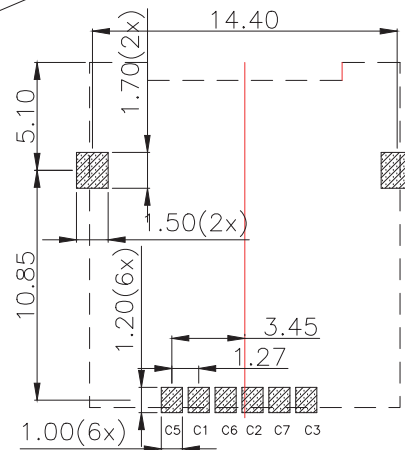
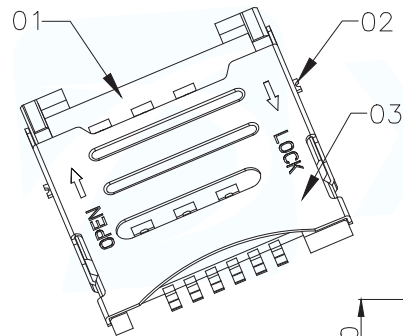
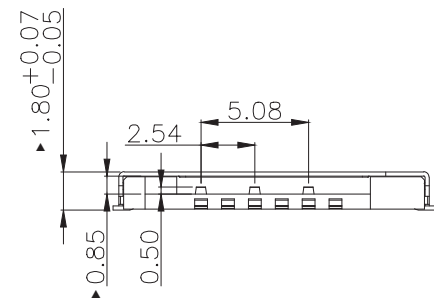
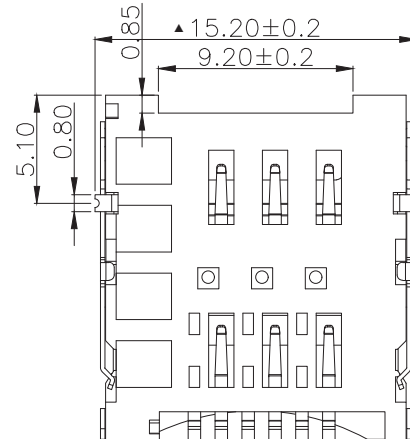
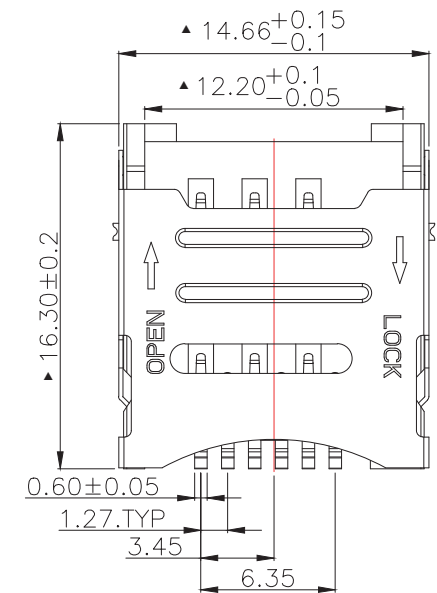
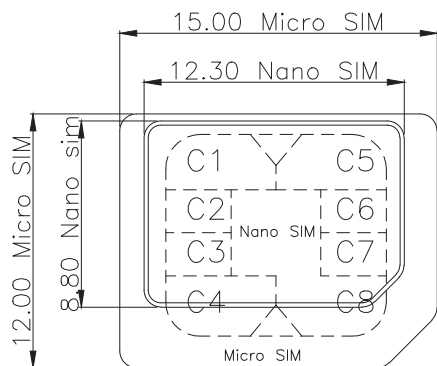




▨ PAD AREA
■ KEEP OUT AREA

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



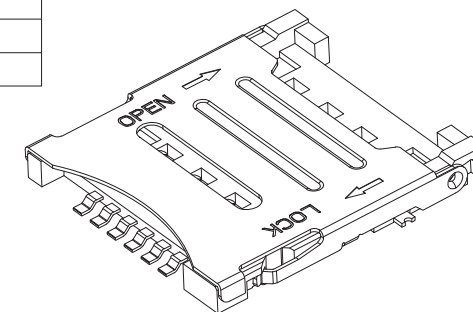
一、材质和镀涂:

- 1、胶芯: LCP,UL 94V-O,黑色
- 2、端子: 磷铜C5210-H, T=0.15, 镍底镀金
- 3、外壳: 不锈钢SUS304 T=0.2

二、技术参数:

接触电阻: 100MΩ MAX
绝缘阻抗: 1000MΩ MIN(500DC)
额定电流: 每个接触件1A MAX
额定电压: 30V MAX(DC)
耐压: 500V R.M.S/MIN
使用温度: -40℃~85℃
湿度: 90%~95%
寿命: >5000次

MICRO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: MICRO SIM CARD HINGED 6PIN H1.8 微插式
			PAR SMC-216-ARP6
DECIMALS:	ANGLES:		DWN
X.:±0.50	X':±2°		CHKD
X.X:±0.30	X.X':±1°		APVD
X.XX:±0.20		CUSTOMER COPY	SCALE 1:1 UNIT:MM
			SIZE: A4 SHEET: 1F1 REV: A



-
- 空 15PCS
- 产品 1200PCS
- 空 5PCS
- 轴心段空 300mm
- 尾部 100mm
- 产品放置区

- 3.每箱包装数量:12000PCS/箱
- 4.纸箱350mm*350mm*440mm(内部尺寸),材质K=K

